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THERMAL RESISTANCE RATINGS							
PARAMETER	SYMBOL	TYP.	MAX.	UNIT			
Maximum Junction-to-Ambient	R _{thJA}	-	62				
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.50	-	°C/W			
Maximum Junction-to-Case (Drain)	R _{thJC}	-	1.0				

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA		60	-	_	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	Reference to 25 °C, I _D = 1 mA		0.060	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}, I_D = 250 \mu A$		-	4.0	V
Gate-Source Leakage	I_{GSS}	$V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$		-	-	25	μΑ
·			$V_{DS} = 48 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 \text{ °C}$		-	250	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	$I_D = 31 A^b$	-	-	0.028	Ω
Forward Transconductance	9 _{fs}	V _{DS}	= 25 V, I _D = 31 A	15	-	-	S
Dynamic					T	1	
Input Capacitance	C_{iss}		$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$		1900	-	pF
Output Capacitance	C _{oss}				920	-	
Reverse Transfer Capacitance	C_{rss}	T = 1.	0 MHz, see fig. 5	-	170	-	
Total Gate Charge	Q_g			-	-	67	
Gate-Source Charge	Q_{gs}	V _{GS} = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 51 \text{ A}, V_{DS} = 48 \text{ V},$ see fig. 6 and 13 ^b		-	18	nC
Gate-Drain Charge	Q_{gd}				-	25	
Turn-On Delay Time	t _{d(on)}	·		-	14	-	- ns
Rise Time	t _r	V _{DD} :	$V_{DD} = 30 \text{ V, } I_{D} = 51 \text{ A,}$ $R_{g} = 9.1 \Omega, R_{D} = 0.55 \Omega, \text{ see fig. } 10^{b}$		110		
Turn-Off Delay Time	t _{d(off)}	$R_g = 9.1 \Omega$			45	-	
Fall Time	t _f			-	92	-	
Internal Drain Inductance	L_D		Between lead, 6 mm (0.25") from		4.5	-	- nH
Internal Source Inductance	L _S	package and center of die contact		-	7.5	-	
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	50	A
Pulsed Diode Forward Current ^a	I _{SM}			-	-	200	
Body Diode Voltage	V_{SD}	$T_J = 25 ^{\circ}\text{C}, I_S = 51 \text{A}, V_{GS} = 0 \text{V}^{\text{b}}$		-	-	2.5	V
Body Diode Reverse Recovery Time	t _{rr}	T _J = 25 °C, I _F = 51 A, dl/dt = 100 A/μs		-	120	180	ns
Body Diode Reverse Recovery Charge	Q _{rr}			-	0.53	0.80	nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L_S and L_D)					

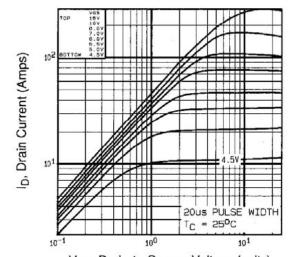
Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width \leq 300 µs; duty cycle \leq 2 %.

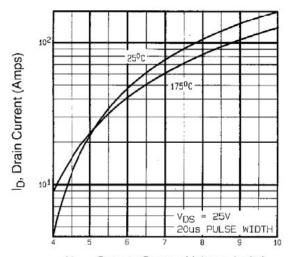




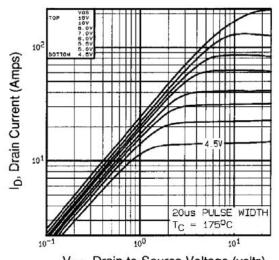
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



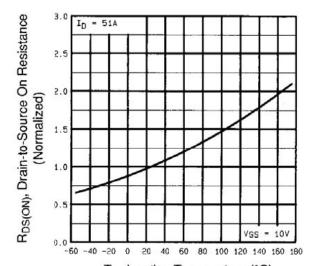
 V_{DS} , Drain-to-Source Voltage (volts) Fig. 1 - Typical Output Characteristics, $T_C = 25$ °C



V_{GS}, Gate-to-Source Voltage (volts) Fig. 1 - Typical Transfer Characteristics



 V_{DS} , Drain-to-Source Voltage (volts) Fig. 2 - Typical Output Characteristics, $T_C = 175$ °C



T_J, Junction Temperature (°C)
Fig. 2 - Normalized On-Resistance vs. Temperature

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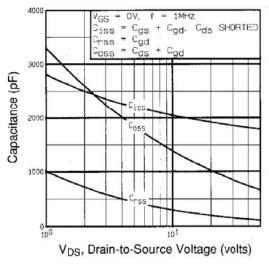


Fig. 3 - Typical Capacitance vs. Drain-to-Source Voltage

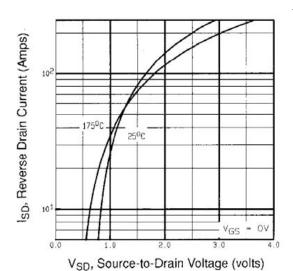


Fig. 5 - Typical Source-Drain Diode Forward Voltage

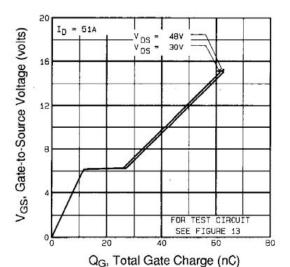


Fig. 4 - Typical Gate Charge vs. Gate-to-Source Voltage

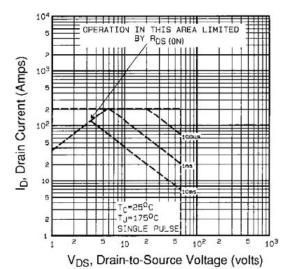


Fig. 3 - Maximum Safe Operating Area





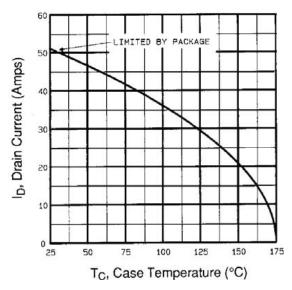


Fig. 9 - Maximum Drain Current vs. Case Temperature

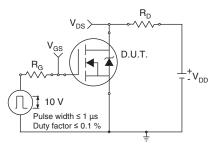


Fig. 10a - Switching Time Test Circuit

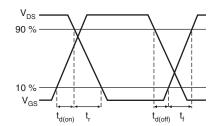


Fig. 10b - Switching Time Waveforms

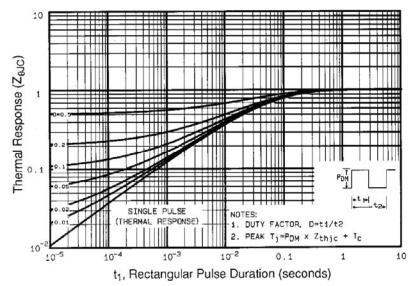


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

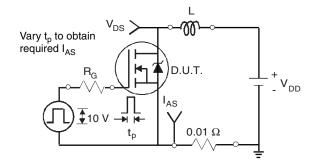


Fig. 12a - Unclamped Inductive Test Circuit

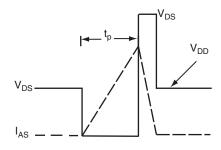


Fig. 12b - Unclamped Inductive Waveforms

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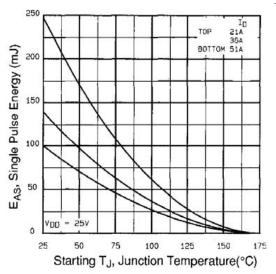


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

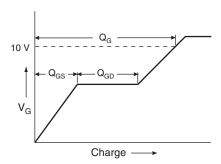


Fig. 13a - Basic Gate Charge Waveform

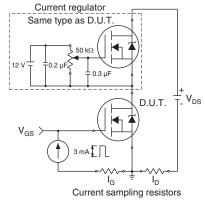
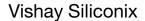
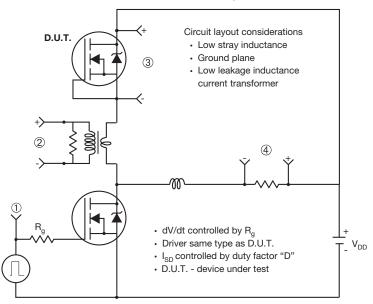


Fig. 13b - Gate Charge Test





Peak Diode Recovery dV/dt Test Circuit



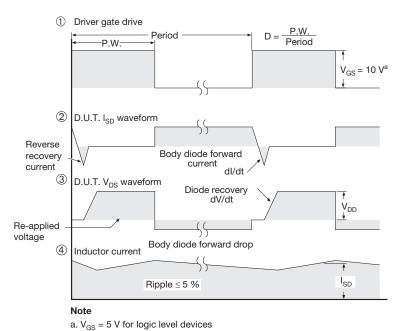


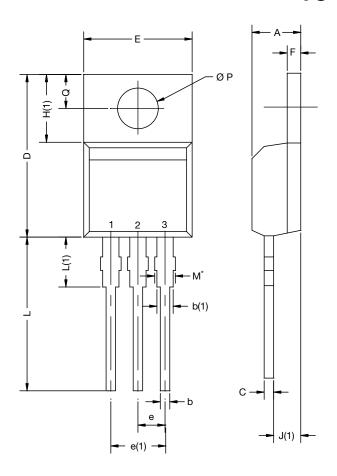
Fig. 14 - For N-Channel

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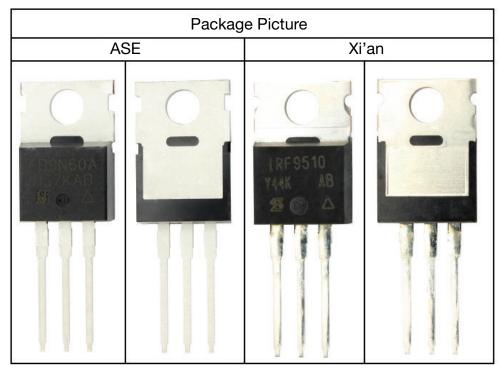
TO-220-1



DIM.	MILLIM	IETERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
Α	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
E	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØΡ	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

Note

 \bullet $M^{\star}=0.052$ inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



Revison: 14-Dec-15 1 Document Number: 66542

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